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Understanding [Embedded - FPGAs \(Field Programmable Gate Array\)](#)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details

Product Status	Obsolete
Number of LABs/CLBs	11648
Number of Logic Elements/Cells	-
Total RAM Bits	3096576
Number of I/O	1108
Number of Gates	8000000
Voltage - Supply	1.425V ~ 1.575V
Mounting Type	Surface Mount
Operating Temperature	-40°C ~ 100°C (TJ)
Package / Case	1517-BBGA, FCBGA
Supplier Device Package	1517-FCBGA (40x40)
Purchase URL	https://www.e-xfl.com/product-detail/xilinx/xc2v8000-4ffg1517i

The Virtex-II implementation process is comprised of Synthesis, translation, mapping, place and route, and configuration file generation. While the tools can be run individually, many designers choose to run the entire implementation process with the click of a button. To assist those who prefer to script their design flows, Xilinx provides Xflow, an automated single command line process.

Design Verification

In addition to conventional design verification using static timing analysis or simulation techniques, Xilinx offers powerful in-circuit debugging techniques using ChipScope ILA (Integrated Logic Analysis). The reconfigurable nature of Xilinx FPGAs means that designs can be verified in real time without the need for extensive sets of software simulation vectors.

For simulation, the system extracts post-layout timing information from the design database, and back-annotates this information into the netlist for use by the simulator. The back annotation features a variety of patented Xilinx techniques, resulting in the industry's most powerful simulation flows. Alternatively, timing-critical portions of a design can be verified using the Xilinx static timing analyzer or a third party static timing analysis tool like Synopsys Prime Time™, by exporting timing data in the STAMP data format.

For in-circuit debugging, ChipScope ILA enables designers to analyze the real-time behavior of a device while operating at full system speeds. Logic analysis commands and captured data are transferred between the ChipScope software and ILA cores within the Virtex-II FPGA, using industry standard JTAG protocols. These JTAG transactions are driven over an optional download cable (MultiLINX or JTAG), connecting the Virtex device in the target system to a PC or workstation.

ChipScope ILA was designed to look and feel like a logic analyzer, making it easy to begin debugging a design immediately. Modifications to the desired logic analysis can be downloaded directly into the system in a matter of minutes.

Other Unique Features of Virtex-II Design Flow

Xilinx design flows feature a number of unique capabilities. Among these are efficient incremental HDL design flows; a

robust capability that is enabled by Xilinx exclusive hierarchical floorplanning capabilities. Another powerful design capability only available in the Xilinx design flow is "Modular Design", part of the Xilinx suite of team design tools, which enables autonomous design, implementation, and verification of design modules.

Incremental Synthesis

Xilinx unique hierarchical floorplanning capabilities enable designers to create a programmable logic design by isolating design changes within one hierarchical "logic block", and perform synthesis, verification and implementation processes on that specific logic block. By preserving the logic in unchanged portions of a design, Xilinx incremental design makes the high-density design process more efficient.

Xilinx hierarchical floorplanning capabilities can be specified using the high-level floorplanner or a preferred RTL floorplanner (see the Xilinx web site for a list of supported EDA partners). When used in conjunction with one of the EDA partners' floorplanners, higher performance results can be achieved, as many synthesis tools use this more predictable detailed physical implementation information to establish more aggressive and accurate timing estimates when performing their logic optimizations.

Modular Design

Xilinx innovative modular design capabilities take the incremental design process one step further by enabling the designer to delegate responsibility for completing the design, synthesis, verification, and implementation of a hierarchical "logic block" to an arbitrary number of designers - assigning a specific region within the target FPGA for exclusive use by each of the team members.

This team design capability enables an autonomous approach to design modules, changing the hand-off point to the lead designer or integrator from "my module works in simulation" to "my module works in the FPGA". This unique design methodology also leverages the Xilinx hierarchical floorplanning capabilities and enables the Xilinx (or EDA partner) floorplanner to manage the efficient implementation of very high-density FPGAs.

Virtex-II Performance Characteristics

This section provides the performance characteristics of some common functions and designs implemented in Virtex-II devices. The numbers reported here are worst-case values; they have all been fully characterized. Note that these values are subject to the same guidelines as [Virtex-II Switching Characteristics, page 9](#) (speed files).

Table 11 provides pin-to-pin values (in nanoseconds) including IOB delays; that is, delay through the device from input pin to output pin. In the case of multiple inputs and outputs, the worst delay is reported.

Table 11: Pin-to-Pin Performance

Description	Device Used & Speed Grade	Pin-to-Pin (with I/O delays)	Units
Basic Functions			
16-bit Address Decoder	XC2V1000 -5	6.3	ns
32-bit Address Decoder	XC2V1000 -5	7.7	ns
64-bit Address Decoder	XC2V1000 -5	9.3	ns
4:1 MUX	XC2V1000 -5	5.7	ns
8:1 MUX	XC2V1000 -5	6.5	ns
16:1 MUX	XC2V1000 -5	6.7	ns
32:1 MUX	XC2V1000 -5	8.7	ns
Combinatorial (pad to LUT to pad)	XC2V1000 -5	5.0	ns
Memory			
Block RAM			
Pad to setup		1.6	ns
Clock to Pad		9.5	ns
Distributed RAM			
Pad to setup	XC2V1000 -5	2.7	ns
Clock to Pad	XC2V1000 -5	5.1 (no clk skew)	ns

Table 12 shows internal (register-to-register) performance. Values are reported in MHz.

Table 12: Register-to-Register Performance

Description	Device Used & Speed Grade	Register-to-Register Performance	Units
Basic Functions			
16-bit Address Decoder	XC2V1000 -5	398	MHz
32-bit Address Decoder	XC2V1000 -5	291	MHz
64-bit Address Decoder	XC2V1000 -5	274	MHz
4:1 MUX	XC2V1000 -5	563	MHz
8:1 MUX	XC2V1000 -5	454	MHz
16:1 MUX	XC2V1000 -5	414	MHz
32:1 MUX	XC2V1000 -5	323	MHz
Register to LUT to Register	XC2V1000 -5	613	MHz

IOB Output Switching Characteristics Standard Adjustments

Table 17 gives all standard-specific adjustments for output delays terminating at pads, based on standard capacitive load, C_{REF} . Output delays terminating at a pad are specified for LVTTTL with 12 mA drive and fast slew rate. For other standards, adjust the delays by the values shown.

Table 17: IOB Output Switching Characteristics Standard Adjustments

Description	IOSTANDARD Attribute	Timing Parameter	Speed Grade			Units
			-6	-5	-4	
LVTTTL (Low-Voltage Transistor-Transistor Logic), Slow, 2 mA	LVTTTL_S2	$T_{OLVTTTL_S2}$	9.42	9.71	10.68	ns
LVTTTL, Slow, 4 mA	LVTTTL_S4	$T_{OLVTTTL_S4}$	5.77	5.95	6.55	ns
LVTTTL, Slow, 6 mA	LVTTTL_S6	$T_{OLVTTTL_S6}$	4.11	4.24	4.66	ns
LVTTTL, Slow, 8 mA	LVTTTL_S8	$T_{OLVTTTL_S8}$	2.87	2.96	3.26	ns
LVTTTL, Slow, 12 mA	LVTTTL_S12	$T_{OLVTTTL_S12}$	2.32	2.39	2.63	ns
LVTTTL, Slow, 16 mA	LVTTTL_S16	$T_{OLVTTTL_S16}$	1.70	1.75	1.93	ns
LVTTTL, Slow, 24 mA	LVTTTL_S24	$T_{OLVTTTL_S24}$	1.26	1.30	1.43	ns
LVTTTL, Fast, 2 mA	LVTTTL_F2	$T_{OLVTTTL_F2}$	6.52	6.72	7.39	ns
LVTTTL, Fast, 4 mA	LVTTTL_F4	$T_{OLVTTTL_F4}$	2.80	2.88	3.17	ns
LVTTTL, Fast, 6 mA	LVTTTL_F6	$T_{OLVTTTL_F6}$	1.57	1.62	1.78	ns
LVTTTL, Fast, 8 mA	LVTTTL_F8	$T_{OLVTTTL_F8}$	0.46	0.48	0.52	ns
LVTTTL, Fast, 12 mA	LVTTTL_F12	$T_{OLVTTTL_F12}$	0.00	0.00	0.00	ns
LVTTTL, Fast, 16 mA	LVTTTL_F16	$T_{OLVTTTL_F16}$	-0.13	-0.14	-0.15	ns
LVTTTL, Fast, 24 mA	LVTTTL_F24	$T_{OLVTTTL_F24}$	-0.22	-0.23	-0.26	ns
LVC MOS (Low-Voltage CMOS), 3.3V, Slow, 2 mA	LVC MOS33_S2	$T_{OLVCMOS33_S2}$	7.67	7.91	8.70	ns
LVC MOS, 3.3V, Slow, 4 mA	LVC MOS33_S4	$T_{OLVCMOS33_S4}$	4.37	4.50	4.95	ns
LVC MOS, 3.3V, Slow, 6 mA	LVC MOS33_S6	$T_{OLVCMOS33_S6}$	3.34	3.44	3.78	ns
LVC MOS, 3.3V, Slow, 8 mA	LVC MOS33_S8	$T_{OLVCMOS33_S8}$	2.29	2.36	2.60	ns
LVC MOS, 3.3V, Slow, 12 mA	LVC MOS33_S12	$T_{OLVCMOS33_S12}$	1.91	1.97	2.16	ns
LVC MOS, 3.3V, Slow, 16 mA	LVC MOS33_S16	$T_{OLVCMOS33_S16}$	1.24	1.27	1.40	ns
LVC MOS, 3.3V, Slow, 24 mA	LVC MOS33_S24	$T_{OLVCMOS33_S24}$	1.18	1.22	1.34	ns
LVC MOS, 3.3V, Fast, 2 mA	LVC MOS33_F2	$T_{OLVCMOS33_F2}$	5.82	6.00	6.60	ns
LVC MOS, 3.3V, Fast, 4 mA	LVC MOS33_F4	$T_{OLVCMOS33_F4}$	2.48	2.55	2.81	ns
LVC MOS, 3.3V, Fast, 6 mA	LVC MOS33_F6	$T_{OLVCMOS33_F6}$	1.28	1.31	1.45	ns
LVC MOS, 3.3V, Fast, 8 mA	LVC MOS33_F8	$T_{OLVCMOS33_F8}$	0.48	0.49	0.54	ns
LVC MOS, 3.3V, Fast, 12 mA	LVC MOS33_F12	$T_{OLVCMOS33_F12}$	0.27	0.28	0.31	ns
LVC MOS, 3.3V, Fast, 16 mA	LVC MOS33_F16	$T_{OLVCMOS33_F16}$	-0.14	-0.14	-0.15	ns
LVC MOS, 3.3V, Fast, 24 mA	LVC MOS33_F24	$T_{OLVCMOS33_F24}$	-0.21	-0.21	-0.23	ns
LVC MOS, 2.5V, Slow, 2 mA	LVC MOS25_S2	$T_{OLVCMOS25_S2}$	9.11	9.39	10.33	ns
LVC MOS, 2.5V, Slow, 4 mA	LVC MOS25_S4	$T_{OLVCMOS25_S4}$	5.00	5.16	5.67	ns
LVC MOS, 2.5V, Slow, 6 mA	LVC MOS25_S6	$T_{OLVCMOS25_S6}$	4.53	4.67	5.13	ns
LVC MOS, 2.5V, Slow, 8 mA	LVC MOS25_S8	$T_{OLVCMOS25_S8}$	3.86	3.98	4.38	ns
LVC MOS, 2.5V, Slow, 12 mA	LVC MOS25_S12	$T_{OLVCMOS25_S12}$	2.84	2.93	3.22	ns
LVC MOS, 2.5V, Slow, 16 mA	LVC MOS25_S16	$T_{OLVCMOS25_S16}$	2.36	2.43	2.67	ns
LVC MOS, 2.5V, Slow, 24 mA	LVC MOS25_S24	$T_{OLVCMOS25_S24}$	2.00	2.06	2.27	ns
LVC MOS, 2.5V, Fast, 2 mA	LVC MOS25_F2	$T_{OLVCMOS25_F2}$	4.06	4.18	4.60	ns
LVC MOS, 2.5V, Fast, 4 mA	LVC MOS25_F4	$T_{OLVCMOS25_F4}$	1.15	1.18	1.30	ns
LVC MOS, 2.5V, Fast, 6 mA	LVC MOS25_F6	$T_{OLVCMOS25_F6}$	0.72	0.74	0.81	ns
LVC MOS, 2.5V, Fast, 8 mA	LVC MOS25_F8	$T_{OLVCMOS25_F8}$	0.33	0.34	0.37	ns
LVC MOS, 2.5V, Fast, 12 mA	LVC MOS25_F12	$T_{OLVCMOS25_F12}$	0.02	0.02	0.03	ns

Table 17: IOB Output Switching Characteristics Standard Adjustments (Continued)

Description	IOSTANDARD Attribute	Timing Parameter	Speed Grade			Units
			-6	-5	-4	
LVC MOS, 2.5V, Fast, 16 mA	LVC MOS25_F16	T _{OLVCMOS25_F16}	−0.18	−0.19	−0.21	ns
LVC MOS, 2.5V, Fast, 24 mA	LVC MOS25_F24	T _{OLVCMOS25_F24}	−0.35	−0.36	−0.40	ns
LVC MOS, 1.8V, Slow, 2 mA	LVC MOS18_S2	T _{OLVCMOS18_S2}	15.62	16.10	17.71	ns
LVC MOS, 1.8V, Slow, 4 mA	LVC MOS18_S4	T _{OLVCMOS18_S4}	10.20	10.51	11.57	ns
LVC MOS, 1.8V, Slow, 6 mA	LVC MOS18_S6	T _{OLVCMOS18_S6}	7.52	7.75	8.53	ns
LVC MOS, 1.8V, Slow, 8 mA	LVC MOS18_S8	T _{OLVCMOS18_S8}	6.87	7.08	7.78	ns
LVC MOS, 1.8V, Slow, 12 mA	LVC MOS18_S12	T _{OLVCMOS18_S12}	5.54	5.71	6.28	ns
LVC MOS, 1.8V, Slow, 16 mA	LVC MOS18_S16	T _{OLVCMOS18_S16}	5.31	5.47	6.02	ns
LVC MOS, 1.8V, Fast, 2 mA	LVC MOS18_F2	T _{OLVCMOS18_F2}	5.55	5.72	6.30	ns
LVC MOS, 1.8V, Fast, 4 mA	LVC MOS18_F4	T _{OLVCMOS18_F4}	1.89	1.95	2.15	ns
LVC MOS, 1.8V, Fast, 6 mA	LVC MOS18_F6	T _{OLVCMOS18_F6}	0.83	0.85	0.94	ns
LVC MOS, 1.8V, Fast, 8 mA	LVC MOS18_F8	T _{OLVCMOS18_F8}	0.70	0.72	0.80	ns
LVC MOS, 1.8V, Fast, 12 mA	LVC MOS18_F12	T _{OLVCMOS18_F12}	0.26	0.27	0.30	ns
LVC MOS, 1.8V, Fast, 16 mA	LVC MOS18_F16	T _{OLVCMOS18_F16}	0.23	0.23	0.26	ns
LVC MOS, 1.5V, Slow, 2 mA	LVC MOS15_S2	T _{OLVCMOS15_S2}	18.96	19.55	21.50	ns
LVC MOS, 1.5V, Slow, 4 mA	LVC MOS15_S4	T _{OLVCMOS15_S4}	12.77	13.17	14.48	ns
LVC MOS, 1.5V, Slow, 6 mA	LVC MOS15_S6	T _{OLVCMOS15_S6}	12.05	12.42	13.66	ns
LVC MOS, 1.5V, Slow, 8 mA	LVC MOS15_S8	T _{OLVCMOS15_S8}	9.75	10.06	11.06	ns
LVC MOS, 1.5V, Slow, 12 mA	LVC MOS15_S12	T _{OLVCMOS15_S12}	9.04	9.32	10.25	ns
LVC MOS, 1.5V, Slow, 16 mA	LVC MOS15_S16	T _{OLVCMOS15_S16}	8.21	8.46	9.31	ns
LVC MOS, 1.5V, Fast, 2 mA	LVC MOS15_F2	T _{OLVCMOS15_F2}	5.09	5.25	5.78	ns
LVC MOS, 1.5V, Fast, 4 mA	LVC MOS15_F4	T _{OLVCMOS15_F4}	2.01	2.07	2.27	ns
LVC MOS, 1.5V, Fast, 6 mA	LVC MOS15_F6	T _{OLVCMOS15_F6}	1.46	1.51	1.66	ns
LVC MOS, 1.5V, Fast, 8 mA	LVC MOS15_F8	T _{OLVCMOS15_F8}	0.93	0.96	1.05	ns
LVC MOS, 1.5V, Fast, 12 mA	LVC MOS15_F12	T _{OLVCMOS15_F12}	0.74	0.77	0.84	ns
LVC MOS, 1.5V, Fast, 16 mA	LVC MOS15_F16	T _{OLVCMOS15_F16}	0.67	0.69	0.75	ns
LVDS (Low-Voltage Differential Signaling), 2.5V	LVDS_25	T _{OLVDS_25}	−0.31	−0.32	−0.36	ns
LVDS, 3.3V	LVDS_33	T _{OLVDS_33}	−0.25	−0.26	−0.29	ns
LVDSEXT (LVDS Extended Mode), 2.5V	LVDSEXT_25	T _{OLVDSEXT_25}	−0.18	−0.19	−0.21	ns
LVDSEXT, 3.3V	LVDSEXT_33	T _{OLVDSEXT_33}	−0.17	−0.18	−0.19	ns
ULVDS (Ultra LVDS), 2.5V	ULVDS_25	T _{OLVDS_25}	−0.20	−0.21	−0.23	ns
BLVDS (Bus LVDS), 2.5V	BLVDS_25	T _{OBLVDS_25}	0.67	0.69	0.76	ns
LDT (HyperTransport), 2.5V	LDT_25	T _{OLDT_25}	−0.20	−0.21	−0.23	ns
LVPECL (Low-Voltage Positive Electron-Coupled Logic), 3.3V	LVPECL_33	T _{OLVPECL_33}	0.29	0.30	0.33	ns
PCI (Peripheral Component Interface), 33 MHz, 3.3V	PCI33_3	T _{OPCI33_3}	1.15	1.19	1.31	ns
PCI, 66 MHz, 3.3V	PCI66_3	T _{OPCI66_3}	−0.01	−0.01	−0.01	ns
PCI-X, 133 MHz, 3.3V	PCIX	T _{OPCIX}	−0.01	−0.01	−0.01	ns
GTL (Gunning Transceiver Logic)	GTL	T _{OGTL}	−0.31	−0.32	−0.36	ns
GTL Plus	GTL P	T _{OGTLP}	−0.17	−0.18	−0.20	ns
HSTL (High-Speed Transceiver Logic), Class I	HSTL_I	T _{OHSTL_I}	0.26	0.27	0.29	ns
HSTL, Class II	HSTL_II	T _{OHSTL_II}	−0.15	−0.16	−0.17	ns
HSTL, Class III	HSTL_III	T _{OHSTL_III}	−0.17	−0.17	−0.19	ns
HSTL, Class IV	HSTL_IV	T _{OHSTL_IV}	−0.40	−0.41	−0.45	ns
HSTL, Class I, 1.8V	HSTL_I_18	T _{OHSTL_I_18}	0.03	0.03	0.04	ns

Table 17: IOB Output Switching Characteristics Standard Adjustments (Continued)

Description	IOSTANDARD Attribute	Timing Parameter	Speed Grade			Units
			-6	-5	-4	
HSTL, Class II, 1.8V	HSTL_II_18	T _{OHSTL_II_18}	-0.17	-0.18	-0.20	ns
HSTL, Class III, 1.8V	HSTL_III_18	T _{OHSTL_III_18}	-0.16	-0.16	-0.18	ns
HSTL, Class IV, 1.8V	HSTL_IV_18	T _{OHSTL_IV_18}	-0.39	-0.40	-0.44	ns
SSTL (Stub Series Terminated Logic), Class I, 1.8V	SSTL18_I	T _{OSSTL18_I}	0.20	0.20	0.22	ns
SSTL, Class II, 1.8V	SSTL18_II	T _{OSSTL18_II}	-0.05	-0.05	-0.06	ns
SSTL, Class I, 2.5V	SSTL2_I	T _{OSSTL2_I}	0.21	0.22	0.24	ns
SSTL, Class II, 2.5V	SSTL2_II	T _{OSSTL2_II}	-0.15	-0.16	-0.18	ns
SSTL, Class I, 3.3V	SSTL3_I	T _{OSSTL3_I}	0.29	0.30	0.33	ns
SSTL, Class II, 3.3V	SSTL3_II	T _{OSSTL3_II}	-0.05	-0.05	-0.05	ns
AGP-2X/AGP (Accelerated Graphics Port)	AGP	T _{OAGP}	-0.27	-0.28	-0.31	ns
LVDCI (Low-Voltage Digitally Controlled Impedance), 3.3V	LVDCI_33	T _{OLVDCI_33}	0.74	0.77	0.84	ns
LVDCI, 2.5V	LVDCI_25	T _{OLVDCI_25}	0.78	0.80	0.88	ns
LVDCI, 1.8V	LVDCI_18	T _{OLVDCI_18}	0.84	0.87	0.95	ns
LVDCI, 1.5V	LVDCI_15	T _{OLVDCI_15}	1.82	1.88	2.06	ns
LVDCI, 3.3V, Half-Impedance	LVDCI_DV2_33	T _{OLVDCI_DV2_33}	0.12	0.12	0.13	ns
LVDCI, 2.5V, Half-Impedance	LVDCI_DV2_25	T _{OLVDCI_DV2_25}	0.03	0.03	0.03	ns
LVDCI, 1.8V, Half-Impedance	LVDCI_DV2_18	T _{OLVDCI_DV2_18}	0.42	0.43	0.48	ns
LVDCI, 1.5V, Half-Impedance	LVDCI_DV2_15	T _{OLVDCI_DV2_15}	1.20	1.23	1.36	ns
HSLVDCI (High-Speed Low-Voltage DCI), 1.5V	HSLVDCI_15	T _{OHSLVDCI_15}	1.82	1.88	2.06	ns
HSLVDCI, 1.8V	HSLVDCI_18	T _{OHSLVDCI_18}	1.05	1.08	1.24	ns
HSLVDCI, 2.5V	HSLVDCI_25	T _{OHSLVDCI_25}	0.78	0.80	0.88	ns
HSLVDCI, 3.3V	HSLVDCI_33	T _{OHSLVDCI_33}	0.74	0.77	0.84	ns
GTL (Gunning Transceiver Logic) with DCI	GTL_DCI	T _{OGTL_DCI}	-0.31	-0.32	-0.35	ns
GTL Plus with DCI	GTL_P_DCI	T _{OGTL_P_DCI}	-0.15	-0.16	-0.17	ns
HSTL (High-Speed Transceiver Logic), Class I, with DCI	HSTL_I_DCI	T _{OHSTL_I_DCI}	0.23	0.23	0.26	ns
HSTL, Class II, with DCI	HSTL_II_DCI	T _{OHSTL_II_DCI}	0.06	0.06	0.07	ns
HSTL, Class III, with DCI	HSTL_III_DCI	T _{OHSTL_III_DCI}	-0.17	-0.18	-0.20	ns
HSTL, Class IV, with DCI	HSTL_IV_DCI	T _{OHSTL_IV_DCI}	-0.46	-0.47	-0.52	ns
HSTL, Class I, 1.8V, with DCI	HSTL_I_DCI_18	T _{OHSTL_I_DCI_18}	0.05	0.05	0.06	ns
HSTL, Class II, 1.8V, with DCI	HSTL_II_DCI_18	T _{OHSTL_II_DCI_18}	-0.03	-0.03	-0.03	ns
HSTL, Class III, 1.8V, with DCI	HSTL_III_DCI_18	T _{OHSTL_III_DCI_18}	-0.14	-0.14	-0.16	ns
HSTL, Class IV, 1.8V, with DCI	HSTL_IV_DCI_18	T _{OHSTL_IV_DCI_18}	-0.41	-0.42	-0.47	ns
SSTL (Stub Series Terminated Logic), Class I, 1.8V, with DCI	SSTL18_I_DCI	T _{OSSTL18_I_DCI}	0.36	0.37	0.40	ns
SSTL, Class II, 1.8V, with DCI	SSTL18_II_DCI	T _{OSSTL18_II_DCI}	0.06	0.06	0.07	ns
SSTL, Class I, 2.5V, with DCI	SSTL2_I_DCI	T _{OSSTL2_I_DCI}	0.12	0.13	0.14	ns
SSTL, Class II, 2.5V, with DCI	SSTL2_II_DCI	T _{OSSTL2_II_DCI}	-0.10	-0.10	-0.11	ns
SSTL, Class I, 3.3V, with DCI	SSTL3_I_DCI	T _{OSSTL3_I_DCI}	0.15	0.16	0.17	ns
SSTL, Class II, 3.3V, with DCI	SSTL3_II_DCI	T _{OSSTL3_II_DCI}	0.08	0.08	0.09	ns

Output Clock Jitter

Table 40: Output Clock Jitter

Description	Symbol	Constraints	Speed Grade			Units
			-6	-5	-4	
Clock Synthesis Period Jitter						
CLK0	CLKOUT_PER_JITT_0		±100	±100	±100	ps
CLK90	CLKOUT_PER_JITT_90		±150	±150	±150	ps
CLK180	CLKOUT_PER_JITT_180		±150	±150	±150	ps
CLK270	CLKOUT_PER_JITT_270		±150	±150	±150	ps
CLK2X, CLK2X180	CLKOUT_PER_JITT_2X		±200	±200	±200	ps
CLKDV (integer division)	CLKOUT_PER_JITT_DV1		±150	±150	±150	ps
CLKDV (non-integer division)	CLKOUT_PER_JITT_DV2		±300	±300	±300	ps
CLKFX, CLKFX180	CLKOUT_PER_JITT_FX		Note 1	Note 1	Note 1	ps

Notes:

- Values for this parameter are available at www.xilinx.com.

Output Clock Phase Alignment

Table 41: Output Clock Phase Alignment

Description	Symbol	Constraints	Speed Grade			Units
			-6	-5	-4	
Phase Offset Between CLKIN and CLKFB						
CLKIN/CLKFB	CLKIN_CLKFB_PHASE		±50	±50	±50	ps
Phase Offset Between Any DCM Outputs						
All CLK outputs	CLKOUT_PHASE		±140	±140	±140	ps
Duty Cycle Precision						
DLL outputs ⁽¹⁾	CLKOUT_DUTY_CYCLE_DLL ⁽²⁾		±150	±150	±150	ps
CLKFX outputs	CLKOUT_DUTY_CYCLE_FX		±100	±100	±100	ps

Notes:

- "DLL outputs" is used here to describe the outputs: CLK0, CLK90, CLK180, CLK270, CLK2X, CLK2X180, and CLKDV.
- CLKOUT_DUTY_CYCLE_DLL applies to the 1X clock outputs (CLK0, CLK90, CLK180, and CLK270) only if DUTY_CYCLE_CORRECTION = TRUE.
- Specification also applies to PSCLK.

FG256/FGG256 Fine-Pitch BGA Package

As shown in Table 6, XC2V40, XC2V80, XC2V250, XC2V500, and XC2V1000 Virtex-II devices are available in the FG256/FGG256 fine-pitch BGA package. The pins in the XC2V250, XC2V500, and XC2V1000 devices are same. The No Connect columns show pin differences for the XC2V40 and XC2V80 devices. Following this table are the **FG256/FGG256 Fine-Pitch BGA Package Specifications (1.00mm pitch)**.

Table 6: FG256/FGG256 BGA — XC2V40, XC2V80, XC2V250, XC2V500, and XC2V1000

Bank	Pin Description	Pin Number	No Connect in XC2V40	No Connect in XC2V80
0	IO_L01N_0	C4		
0	IO_L01P_0	B4		
0	IO_L02N_0	D5		
0	IO_L02P_0	C5		
0	IO_L03N_0/VRP_0	B5		
0	IO_L03P_0/VRN_0	A5		
0	IO_L04N_0/VREF_0	D6	NC	NC
0	IO_L04P_0	C6	NC	NC
0	IO_L05N_0	B6	NC	NC
0	IO_L05P_0	A6	NC	NC
0	IO_L92N_0	E6	NC	NC
0	IO_L92P_0	E7	NC	NC
0	IO_L93N_0	D7	NC	NC
0	IO_L93P_0	C7	NC	NC
0	IO_L94N_0/VREF_0	B7		
0	IO_L94P_0	A7		
0	IO_L95N_0/GCLK7P	D8		
0	IO_L95P_0/GCLK6S	C8		
0	IO_L96N_0/GCLK5P	B8		
0	IO_L96P_0/GCLK4S	A8		
1	IO_L96N_1/GCLK3P	A9		
1	IO_L96P_1/GCLK2S	B9		
1	IO_L95N_1/GCLK1P	C9		
1	IO_L95P_1/GCLK0S	D9		
1	IO_L94N_1	A10		
1	IO_L94P_1/VREF_1	B10		
1	IO_L93N_1	C10	NC	NC
1	IO_L93P_1	D10	NC	NC
1	IO_L92N_1	E10	NC	NC

Table 7: FG456/FGG456 BGA — XC2V250, XC2V500, and XC2V1000

Bank	Pin Description	Pin Number	No Connect in XC2V250	No Connect in XC2V500
2	IO_L45N_2	H19		
2	IO_L45P_2/VREF_2	H20		
2	IO_L46N_2	H21		
2	IO_L46P_2	H22		
2	IO_L48N_2	J17		
2	IO_L48P_2	J18		
2	IO_L49N_2	J19	NC	
2	IO_L49P_2	J20	NC	
2	IO_L51N_2	J21	NC	
2	IO_L51P_2/VREF_2	J22	NC	
2	IO_L52N_2	K17	NC	
2	IO_L52P_2	K18	NC	
2	IO_L54N_2	K19	NC	
2	IO_L54P_2	K20	NC	
2	IO_L91N_2	K21		
2	IO_L91P_2	K22		
2	IO_L93N_2	L17		
2	IO_L93P_2/VREF_2	L18		
2	IO_L94N_2	L19		
2	IO_L94P_2	L20		
2	IO_L96N_2	L21		
2	IO_L96P_2	L22		
3	IO_L96N_3	M21		
3	IO_L96P_3	M20		
3	IO_L94N_3	M19		
3	IO_L94P_3	M18		
3	IO_L93N_3/VREF_3	M17		
3	IO_L93P_3	N17		
3	IO_L91N_3	N22		
3	IO_L91P_3	N21		
3	IO_L54N_3	N20	NC	
3	IO_L54P_3	N19	NC	
3	IO_L52N_3	N18	NC	

Table 8: FG676/FGG676 BGA — XC2V1500, XC2V2000, and XC2V3000

Bank	Pin Description	Pin Number	No Connect in XC2V1500	No Connect in XC2V2000
7	IO_L78N_7	M2	NC	
7	IO_L76P_7	M5	NC	
7	IO_L76N_7	M6	NC	
7	IO_L75P_7/VREF_7	M3	NC	
7	IO_L75N_7	M4	NC	
7	IO_L73P_7	M7	NC	
7	IO_L73N_7	M8	NC	
7	IO_L72P_7	L1		
7	IO_L72N_7	L2		
7	IO_L70P_7	L5		
7	IO_L70N_7	L6		
7	IO_L69P_7/VREF_7	L3		
7	IO_L69N_7	L4		
7	IO_L67P_7	K1		
7	IO_L67N_7	J1		
7	IO_L54P_7	K3		
7	IO_L54N_7	K4		
7	IO_L52P_7	K5		
7	IO_L52N_7	K6		
7	IO_L51P_7/VREF_7	L8		
7	IO_L51N_7	L7		
7	IO_L49P_7	J2		
7	IO_L49N_7	H1		
7	IO_L48P_7	J3		
7	IO_L48N_7	J4		
7	IO_L46P_7	J5		
7	IO_L46N_7	J6		
7	IO_L45P_7/VREF_7	H5		
7	IO_L45N_7	H4		
7	IO_L43P_7	K7		
7	IO_L43N_7	J7		
7	IO_L25P_7	H2	NC	NC
7	IO_L25N_7	H3	NC	NC
7	IO_L24P_7	G1		
7	IO_L24N_7	F1		
7	IO_L22P_7	G3		
7	IO_L22N_7	G4		

Table 10: BG728 BGA — XC2V3000

Bank	Pin Description	Pin Number
7	IO_L27P_7/VREF_7	H5
7	IO_L27N_7	H6
7	IO_L25P_7	J7
7	IO_L25N_7	J8
7	IO_L24P_7	G1
7	IO_L24N_7	F1
7	IO_L22P_7	G2
7	IO_L22N_7	G3
7	IO_L21P_7/VREF_7	F2
7	IO_L21N_7	F3
7	IO_L19P_7	G5
7	IO_L19N_7	G6
7	IO_L06P_7	F4
7	IO_L06N_7	F5
7	IO_L04P_7	E1
7	IO_L04N_7	E2
7	IO_L03P_7/VREF_7	D1
7	IO_L03N_7	C1
7	IO_L02P_7/VRN_7	E3
7	IO_L02N_7/VRP_7	E4
7	IO_L01P_7	D2
7	IO_L01N_7	D3
0	VCCO_0	K13
0	VCCO_0	K12
0	VCCO_0	K11
0	VCCO_0	J11
0	VCCO_0	J10
0	VCCO_0	G12
0	VCCO_0	D7
0	VCCO_0	C12
1	VCCO_1	K17
1	VCCO_1	K16
1	VCCO_1	K15
1	VCCO_1	J18
1	VCCO_1	J17

Table 10: BG728 BGA — XC2V3000

Bank	Pin Description	Pin Number
NA	GND	F22
NA	GND	F6
NA	GND	E23
NA	GND	E17
NA	GND	E11
NA	GND	E5
NA	GND	D24
NA	GND	D14
NA	GND	D4
NA	GND	C25
NA	GND	C3
NA	GND	B27
NA	GND	B26
NA	GND	B20
NA	GND	B8
NA	GND	B2
NA	GND	B1
NA	GND	A27
NA	GND	A26
NA	GND	A14
NA	GND	A2

Notes:

1. See Table 4 for an explanation of the signals available on this pin.

Table 12: FF1152 BGA — XC2V3000, XC2V4000, XC2V6000, and XC2V8000

Bank	Pin Description	Pin Number	No Connect in the XC2V3000
2	IO_L81N_2	R7	NC
2	IO_L81P_2/VREF_2	R6	NC
2	IO_L82N_2	U5	NC
2	IO_L82P_2	T5	NC
2	IO_L83N_2	T10	NC
2	IO_L83P_2	U10	NC
2	IO_L84N_2	U4	NC
2	IO_L84P_2	T4	NC
2	IO_L91N_2	T2	
2	IO_L91P_2	R1	
2	IO_L92N_2	U7	
2	IO_L92P_2	T7	
2	IO_L93N_2	T6	
2	IO_L93P_2/VREF_2	U6	
2	IO_L94N_2	U1	
2	IO_L94P_2	U2	
2	IO_L95N_2	U9	
2	IO_L95P_2	U8	
2	IO_L96N_2	U3	
2	IO_L96P_2	V4	
3	IO_L96N_3	V6	
3	IO_L96P_3	W6	
3	IO_L95N_3	V5	
3	IO_L95P_3	W5	
3	IO_L94N_3	V7	
3	IO_L94P_3	W7	
3	IO_L93N_3/VREF_3	V10	
3	IO_L93P_3	W10	
3	IO_L92N_3	V1	
3	IO_L92P_3	V2	
3	IO_L91N_3	W3	
3	IO_L91P_3	Y3	
3	IO_L84N_3	V9	NC
3	IO_L84P_3	V8	NC
3	IO_L83N_3	W4	NC

Table 12: FF1152 BGA — XC2V3000, XC2V4000, XC2V6000, and XC2V8000

Bank	Pin Description	Pin Number	No Connect in the XC2V3000
3	IO_L53P_3	AD2	
3	IO_L52N_3	AC8	
3	IO_L52P_3	AB8	
3	IO_L51N_3/VREF_3	AB10	
3	IO_L51P_3	AC10	
3	IO_L50N_3	AD5	
3	IO_L50P_3	AE5	
3	IO_L49N_3	AE4	
3	IO_L49P_3	AF4	
3	IO_L48N_3	AB9	
3	IO_L48P_3	AC9	
3	IO_L47N_3	AE2	
3	IO_L47P_3	AF1	
3	IO_L46N_3	AD6	
3	IO_L46P_3	AE6	
3	IO_L45N_3/VREF_3	AD9	
3	IO_L45P_3	AE9	
3	IO_L44N_3	AF2	
3	IO_L44P_3	AG2	
3	IO_L43N_3	AF3	
3	IO_L43P_3	AG3	
3	IO_L30N_3	AD7	
3	IO_L30P_3	AE7	
3	IO_L29N_3	AF5	
3	IO_L29P_3	AG5	
3	IO_L28N_3	AE8	
3	IO_L28P_3	AD8	
3	IO_L27N_3/VREF_3	AF8	
3	IO_L27P_3	AF9	
3	IO_L26N_3	AH1	
3	IO_L26P_3	AJ1	
3	IO_L25N_3	AG4	
3	IO_L25P_3	AH5	
3	IO_L24N_3	AF6	
3	IO_L24P_3	AG6	
3	IO_L23N_3	AH3	

Table 12: FF1152 BGA — XC2V3000, XC2V4000, XC2V6000, and XC2V8000

Bank	Pin Description	Pin Number	No Connect in the XC2V3000
7	IO_L03N_7	F30	
7	IO_L02P_7/VRN_7	K25	
7	IO_L02N_7/VRP_7	J25	
7	IO_L01P_7	D33	
7	IO_L01N_7	E33	
0	VCCO_0	M22	
0	VCCO_0	M21	
0	VCCO_0	M20	
0	VCCO_0	M19	
0	VCCO_0	M18	
0	VCCO_0	L23	
0	VCCO_0	L22	
0	VCCO_0	L21	
0	VCCO_0	L20	
0	VCCO_0	E20	
0	VCCO_0	D28	
0	VCCO_0	A25	
0	VCCO_0	A19	
1	VCCO_1	M17	
1	VCCO_1	M16	
1	VCCO_1	M15	
1	VCCO_1	M14	
1	VCCO_1	M13	
1	VCCO_1	L15	
1	VCCO_1	L14	
1	VCCO_1	L13	
1	VCCO_1	L12	
1	VCCO_1	E15	
1	VCCO_1	D7	
1	VCCO_1	A16	
1	VCCO_1	A10	
2	VCCO_2	U12	
2	VCCO_2	T12	
2	VCCO_2	T1	
2	VCCO_2	R12	

Table 13: FF1517 BGA — XC2V4000, XC2V6000, and XC2V8000

Bank	Pin Description	Pin Number	No Connect in the XC2V4000	No Connect in the XC2V6000
0	IO_L76P_0	C24		
0	IO_L77N_0	K22		
0	IO_L77P_0	K21		
0	IO_L78N_0	E22		
0	IO_L78P_0	E23		
0	IO_L79N_0	B23		
0	IO_L79P_0	B24		
0	IO_L80N_0	J22		
0	IO_L80P_0	J21		
0	IO_L81N_0	G21		
0	IO_L81P_0/VREF_0	G22		
0	IO_L82N_0	A23		
0	IO_L82P_0	A24		
0	IO_L83N_0	H22		
0	IO_L83P_0	H21		
0	IO_L84N_0	F21		
0	IO_L84P_0	F22		
0	IO_L91N_0/VREF_0	B21		
0	IO_L91P_0	B22		
0	IO_L92N_0	L20		
0	IO_L92P_0	M20		
0	IO_L93N_0	E21		
0	IO_L93P_0	D22		
0	IO_L94N_0/VREF_0	A21		
0	IO_L94P_0	A22		
0	IO_L95N_0/GCLK7P	H20		
0	IO_L95P_0/GCLK6S	J20		
0	IO_L96N_0/GCLK5P	C21		
0	IO_L96P_0/GCLK4S	D21		
1	IO_L96N_1/GCLK3P	F19		
1	IO_L96P_1/GCLK2S	F20		
1	IO_L95N_1/GCLK1P	H19		
1	IO_L95P_1/GCLK0S	H18		
1	IO_L94N_1	C19		
1	IO_L94P_1/VREF_1	C20		

Table 13: FF1517 BGA — XC2V4000, XC2V6000, and XC2V8000

Bank	Pin Description	Pin Number	No Connect in the XC2V4000	No Connect in the XC2V6000
1	IO_L33N_1/VREF_1	D11	NC	
1	IO_L33P_1	D12	NC	
1	IO_L32N_1	H14	NC	
1	IO_L32P_1	H13	NC	
1	IO_L31N_1	A8	NC	
1	IO_L31P_1	A9	NC	
1	IO_L30N_1	F11		
1	IO_L30P_1	F12		
1	IO_L29N_1	K14		
1	IO_L29P_1	L14		
1	IO_L28N_1	C9		
1	IO_L28P_1	C10		
1	IO_L27N_1/VREF_1	G11		
1	IO_L27P_1	G12		
1	IO_L26N_1	M15		
1	IO_L26P_1	M14		
1	IO_L25N_1	B7		
1	IO_L25P_1	B8		
1	IO_L24N_1	D9		
1	IO_L24P_1	D10		
1	IO_L23N_1	J13		
1	IO_L23P_1	J12		
1	IO_L22N_1	A6		
1	IO_L22P_1	A7		
1	IO_L21N_1/VREF_1	E9		
1	IO_L21P_1	E10		
1	IO_L20N_1	D8		
1	IO_L20P_1	E7		
1	IO_L19N_1	C7		
1	IO_L19P_1	C8		
1	IO_L12N_1	F9	NC	
1	IO_L12P_1	F10	NC	
1	IO_L11N_1	H12	NC	
1	IO_L11P_1	H11	NC	
1	IO_L10N_1	B5	NC	
1	IO_L10P_1	B6	NC	

Table 13: FF1517 BGA — XC2V4000, XC2V6000, and XC2V8000

Bank	Pin Description	Pin Number	No Connect in the XC2V4000	No Connect in the XC2V6000
6	IO_L71N_6	AE39		
6	IO_L72P_6	AD36		
6	IO_L72N_6	AE36		
6	IO_L73P_6	AB29		
6	IO_L73N_6	AA29		
6	IO_L74P_6	AE38		
6	IO_L74N_6	AD38		
6	IO_L75P_6	AC33		
6	IO_L75N_6/VREF_6	AD33		
6	IO_L76P_6	AB30		
6	IO_L76N_6	AA30		
6	IO_L77P_6	AD37		
6	IO_L77N_6	AC37		
6	IO_L78P_6	AB34		
6	IO_L78N_6	AC34		
6	IO_L79P_6	AB31		
6	IO_L79N_6	AA31		
6	IO_L80P_6	AD39		
6	IO_L80N_6	AC39		
6	IO_L81P_6	AB35		
6	IO_L81N_6/VREF_6	AC35		
6	IO_L82P_6	AB32		
6	IO_L82N_6	AA32		
6	IO_L83P_6	AC38		
6	IO_L83N_6	AB38		
6	IO_L84P_6	AA33		
6	IO_L84N_6	AB33		
6	IO_L91P_6	Y28		
6	IO_L91N_6	Y29		
6	IO_L92P_6	AB39		
6	IO_L92N_6	AA39		
6	IO_L93P_6	AA36		
6	IO_L93N_6/VREF_6	AB36		
6	IO_L94P_6	Y31		
6	IO_L94N_6	Y32		
6	IO_L95P_6	AA37		

Table 13: FF1517 BGA — XC2V4000, XC2V6000, and XC2V8000

Bank	Pin Description	Pin Number	No Connect in the XC2V4000	No Connect in the XC2V6000
7	IO_L26P_7	M31		
7	IO_L26N_7	L31		
7	IO_L25P_7	G38		
7	IO_L25N_7	H38		
7	IO_L24P_7	J34		
7	IO_L24N_7	K34		
7	IO_L23P_7	K32		
7	IO_L23N_7	K31		
7	IO_L22P_7	F39		
7	IO_L22N_7	G39		
7	IO_L21P_7/VREF_7	G36		
7	IO_L21N_7	H36		
7	IO_L20P_7	N28		
7	IO_L20N_7	M28		
7	IO_L19P_7	G37		
7	IO_L19N_7	H37		
7	IO_L12P_7	J33	NC	
7	IO_L12N_7	K33	NC	
7	IO_L11P_7	M29	NC	
7	IO_L11N_7	L28	NC	
7	IO_L10P_7	E38	NC	
7	IO_L10N_7	F38	NC	
7	IO_L09P_7/VREF_7	G35	NC	
7	IO_L09N_7	H35	NC	
7	IO_L08P_7	L30	NC	
7	IO_L08N_7	K29	NC	
7	IO_L07P_7	D39	NC	
7	IO_L07N_7	E39	NC	
7	IO_L06P_7	G34		
7	IO_L06N_7	H34		
7	IO_L05P_7	J32		
7	IO_L05N_7	H33		
7	IO_L04P_7	F36		
7	IO_L04N_7	F37		
7	IO_L03P_7/VREF_7	E36		
7	IO_L03N_7	F35		

Table 13: FF1517 BGA — XC2V4000, XC2V6000, and XC2V8000

Bank	Pin Description	Pin Number	No Connect in the XC2V4000	No Connect in the XC2V6000
7	IO_L02P_7/VRN_7	M27		
7	IO_L02N_7/VRP_7	L27		
7	IO_L01P_7	D38		
7	IO_L01N_7	E37		
0	VCCO_0	P25		
0	VCCO_0	P24		
0	VCCO_0	P23		
0	VCCO_0	P22		
0	VCCO_0	P21		
0	VCCO_0	N26		
0	VCCO_0	N25		
0	VCCO_0	N24		
0	VCCO_0	N23		
0	VCCO_0	N22		
0	VCCO_0	N21		
0	VCCO_0	L23		
0	VCCO_0	J25		
0	VCCO_0	G27		
0	VCCO_0	E29		
0	VCCO_0	C22		
0	VCCO_0	B26		
1	VCCO_1	P19		
1	VCCO_1	P18		
1	VCCO_1	P17		
1	VCCO_1	P16		
1	VCCO_1	P15		
1	VCCO_1	N19		
1	VCCO_1	N18		
1	VCCO_1	N17		
1	VCCO_1	N16		
1	VCCO_1	N15		
1	VCCO_1	N14		
1	VCCO_1	L17		
1	VCCO_1	J15		
1	VCCO_1	G13		

Table 13: FF1517 BGA — XC2V4000, XC2V6000, and XC2V8000

Bank	Pin Description	Pin Number	No Connect in the XC2V4000	No Connect in the XC2V6000
NA	GND	D4		
NA	GND	C39		
NA	GND	C38		
NA	GND	C37		
NA	GND	C3		
NA	GND	C2		
NA	GND	C1		
NA	GND	B39		
NA	GND	B38		
NA	GND	B37		
NA	GND	B29		
NA	GND	B11		
NA	GND	B3		
NA	GND	B2		
NA	GND	B1		
NA	GND	A38		
NA	GND	A37		
NA	GND	A20		
NA	GND	A3		
NA	GND	A2		

Notes:

1. See Table 4 for an explanation of the signals available on this pin.